

Supporting Information

Direct Observation of Perovskite Photodetector Performance Enhancement by Atomically-Thin Interface Engineering

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Note S1. Definition of Richardson constant

The Richardson constant (A^*) is expressed as follows: \square

$$A^* = \frac{4\pi q m k_B^2}{h^3}$$

where k_B denotes the Boltzmann constant, q the electronic charge, m the electron mass, and h the Planck constant.^{1,2}

Note S2. Estimation of effective contact area (A_e)

In our C-AFM experimental setup the nanoscale contacts are formed between the conductive tip and sample. We used the Hertz contact theory to estimate the effective contact area.^{3,4} The tip is assumed to be an elastic sphere and the underlying sample surface is assumed to be flat to describe the contact formed between the tip and WS_2 nanosheets, as schematically illustrated in Figure S7a. Figure S7b shows the deformation image of WS_2 /MAPbI₃ heterojunction, which can be used to extract the insert depth of tip. Figure S7c shows the AFM topographic image of RS-15M, which is very sharp to estimate tip's radius (r) at the insert depth. At last, the effective contact area was calculated as:

$$A_e = \pi r^2$$

$\sim 9.63 \text{ nm}^2$ for WS_2 /MAPbI₃ and 6.54 nm^2 for MAPbI₃.

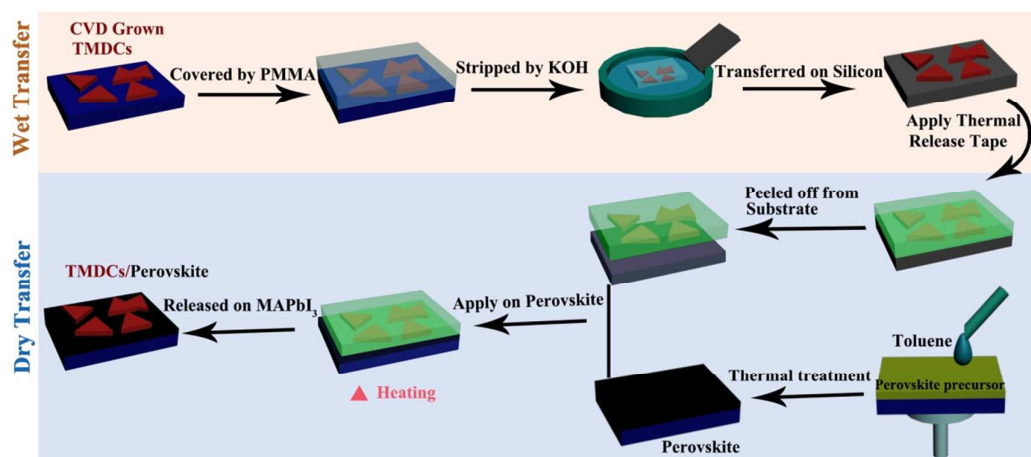


Figure S1. Schematic illustration of the fabrication process of WS₂/MAPbI₃ heterostructure.

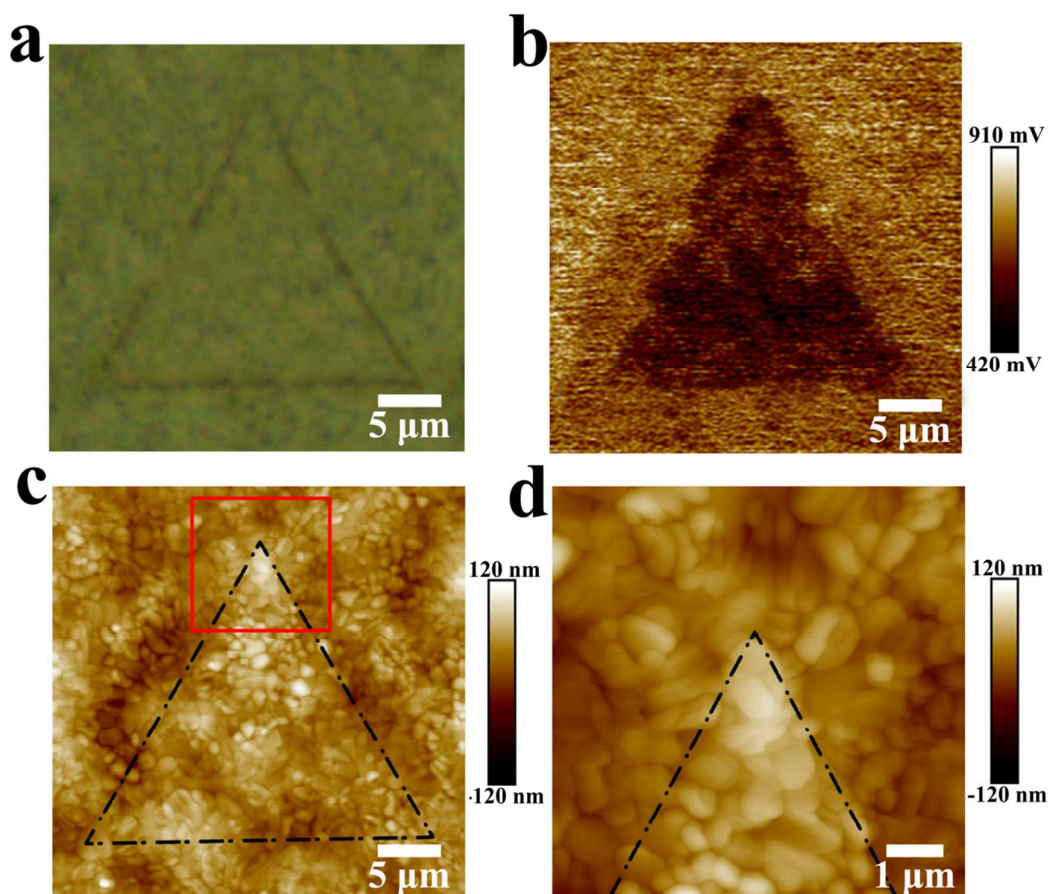


Figure S2. (a) Optical microscope image. (b) Surface potential image of WS₂/MAPbI₃ heterostructure. (c) AFM topographic image. (d) The zoom-in topographic image of the red frame in (c).

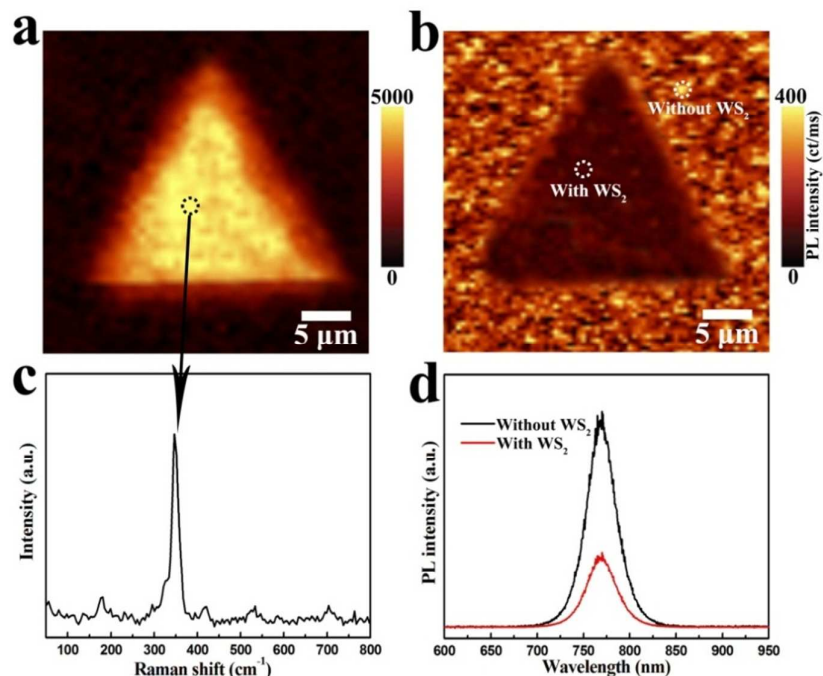


Figure S3. (a) Spatial distribution image of the Raman mapping of WS₂/MAPbI₃ heterostructure. (b) Spatial distribution image of the PL mapping of WS₂/MAPbI₃ heterostructure. (c) Raman spectra at the position as a circle marked in (a). (d) PL spectra at the position as the circles marked in (b).

The spatial distribution images of the Raman and PL intensity mapping of WS₂/MAPbI₃ heterostructure are shown in Figure S3. The Raman intensity distribution of 349 cm⁻¹ peak from WS₂ layer in Figure S3a suggests the continuous distribution of WS₂ layer on perovskite surface without breaking. Additionally, the PL intensity mapping of perovskite exhibits relatively weak PL emission with a wavelength around 775 nm, when MAPbI₃/WS₂ heterostructure was formed. The PL quenching of the MAPbI₃ can be attributed to the interfacial charge transfer, which is also in good consistence with the results in Figure 1f.

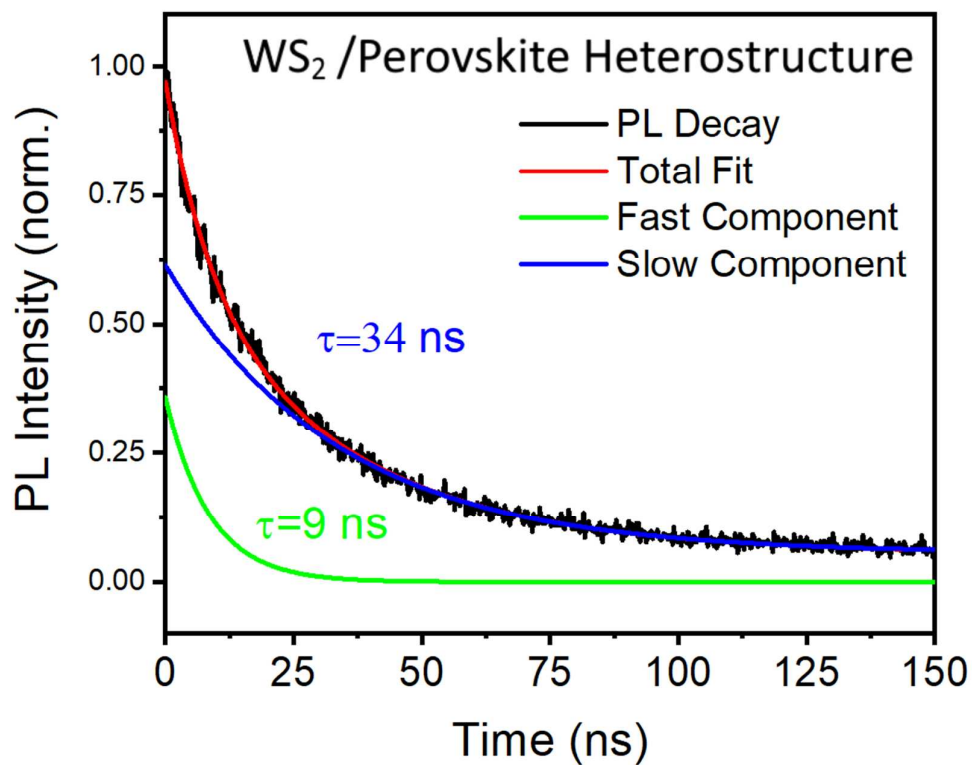


Figure S4. PL time decay trace on a WS₂/MAPbI₃ bilayer with biexponential fits showing a fast ($t \approx 9$ ns) and a slow transient ($t \approx 34$ ns).

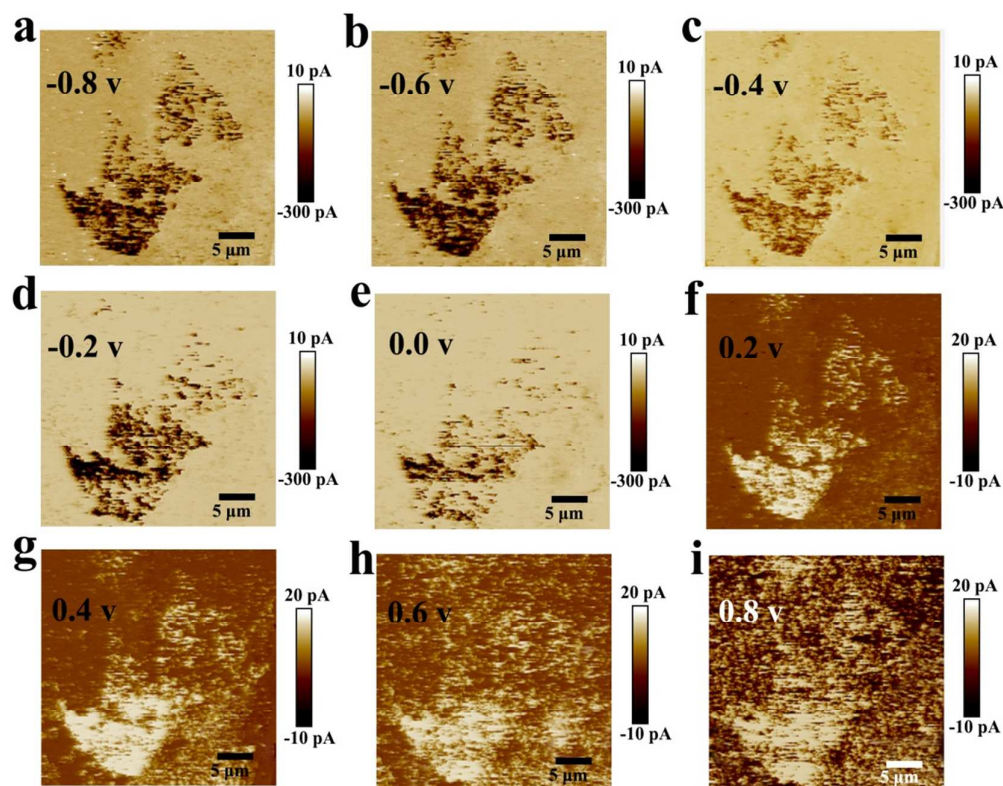


Figure S5. Current maps generated by conductive AFM measurements in dark with applied sample bias voltages of (a) -0.8 V, (b) -0.6 V, (c) -0.4 V, (d) -0.2 V, (e) 0.0 V, (f) 0.2 V, (g) 0.4 V, (h) 0.6 V, and (i) 0.8 V

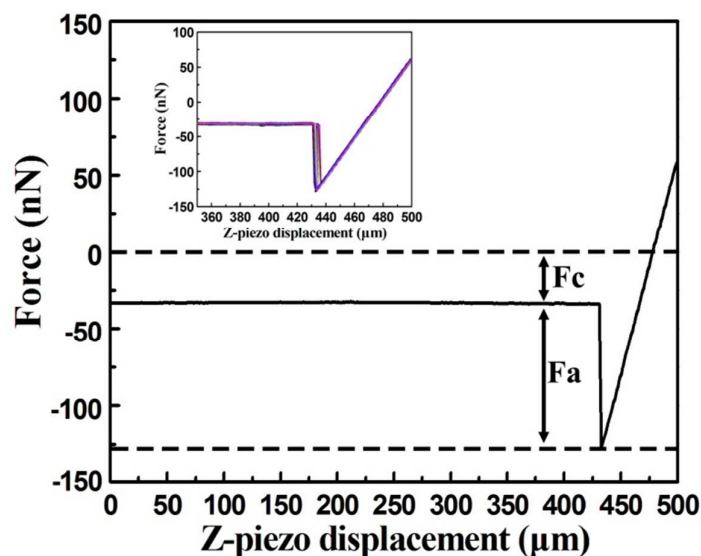


Figure S6. Representative force-displacement (F-D) curve in which F_c represents the instrumental deflection set-point force and F_a shows the additional force between the tip and the sample surface. Inset shows a series of F-D curves taken before and after each of the current images.

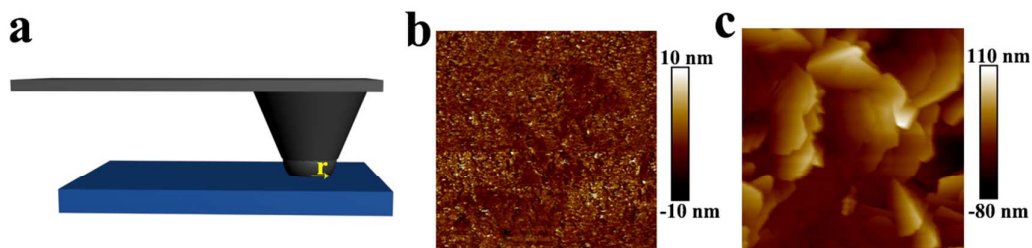


Figure S7. (a) Schematic illustration of the contact status between conductive tip and sample surface, r the contact area radius. (b) Deformation image of $\text{WS}_2/\text{MAPbI}_3$ heterojunction. (c) AFM topographic image of RS-15M.

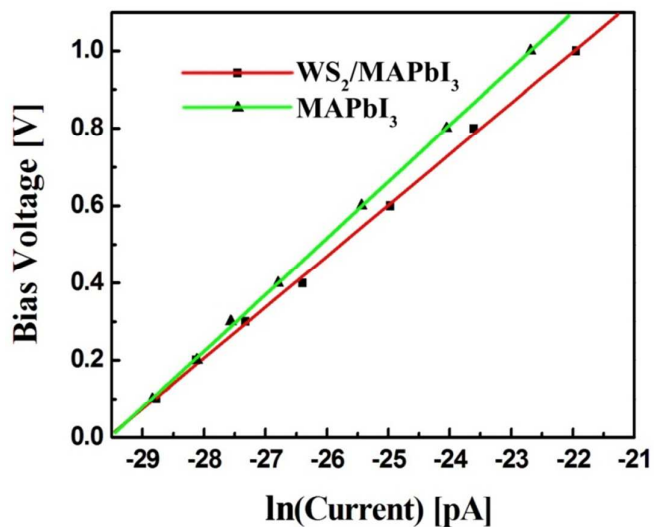


Figure S8. A semilogarithmic plot of bias voltage as a function of $\ln(\text{current})$. The red and green straight lines indicate linear fit to the data.

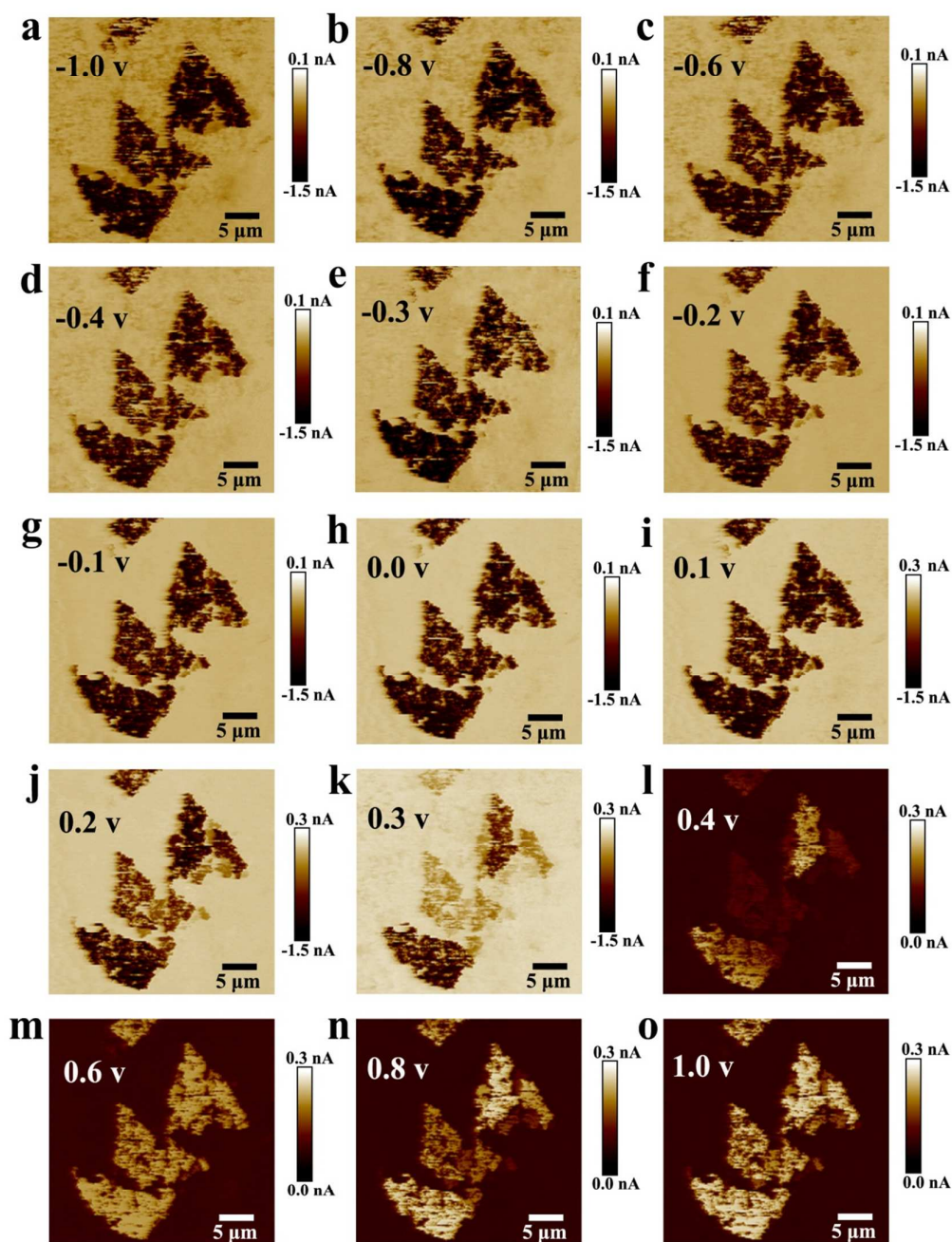


Figure S9. Current maps generated by PC-AFM measurements under laser illumination of $\lambda=532$ nm with applied sample bias voltages of (a) -1.0V, (b) -0.8 V, (c) -0.6 V, (d) -0.4 V, (e) -0.3 V, (f) -0.2 V, (g) -0.1 V, (h) 0.0 V, (i) 0.1 V, (j) 0.2 V, (k) 0.3 V, (l) 0.4 V, (m) 0.6 V, (n) 0.8 V and (o) 1.0 V.

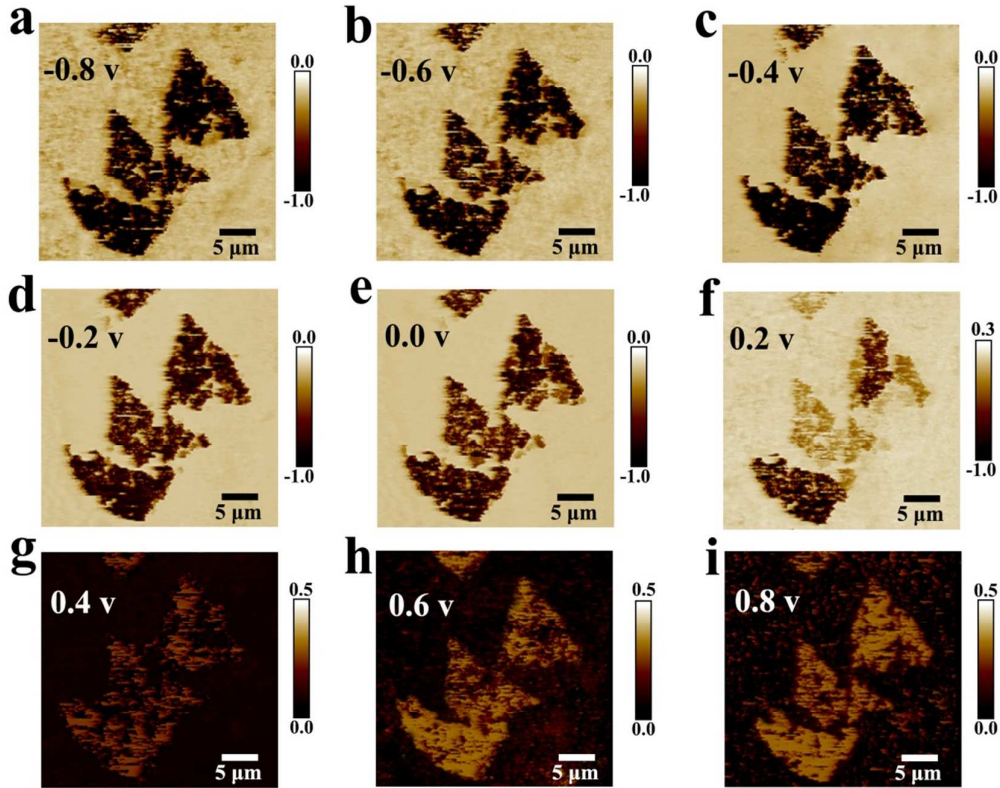


Figure S10. Photoreponse maps at applied sample bias voltages of (a) -0.8 V, (b) -0.6 V, (c) -0.4 V, (d) -0.2 V, (e) 0.0 V, (f) 0.2 V, (g) 0.4 V, (h) 0.6 V, and (i) 0.8 V under illumination of $\lambda=532$ nm.

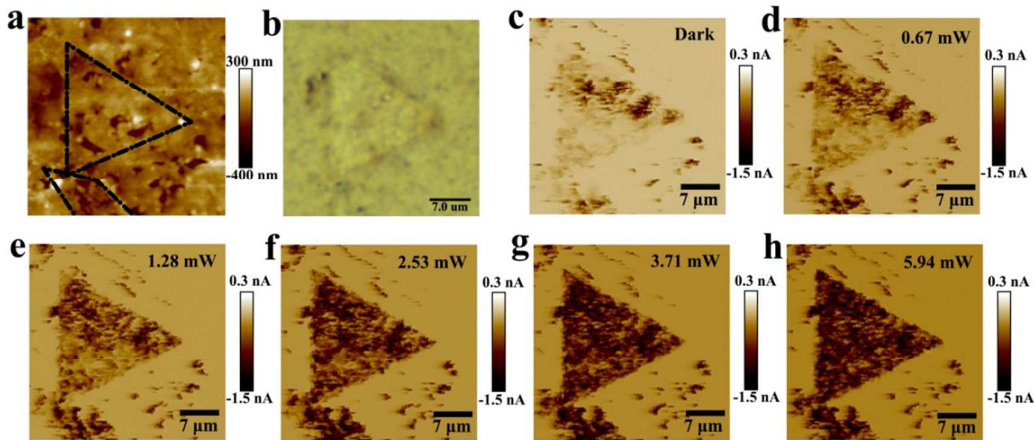


Figure S11. (a) AFM topographic image of the $\text{WS}_2/\text{MAPbI}_3$ heterojunction. (b) Optical microscope image of the $\text{WS}_2/\text{MAPbI}_3$ heterojunction. Photocurrent maps under varying incident laser power of (c) Dark (d) 0.67 mW, (e) 1.28 mW, (f) 2.53 mW, (g) 3.71 mW, (h) 5.94 mW under illumination of $\lambda=532$ nm, which are used to generate the photoreponse maps presented in Figure 6a-e in the main text.

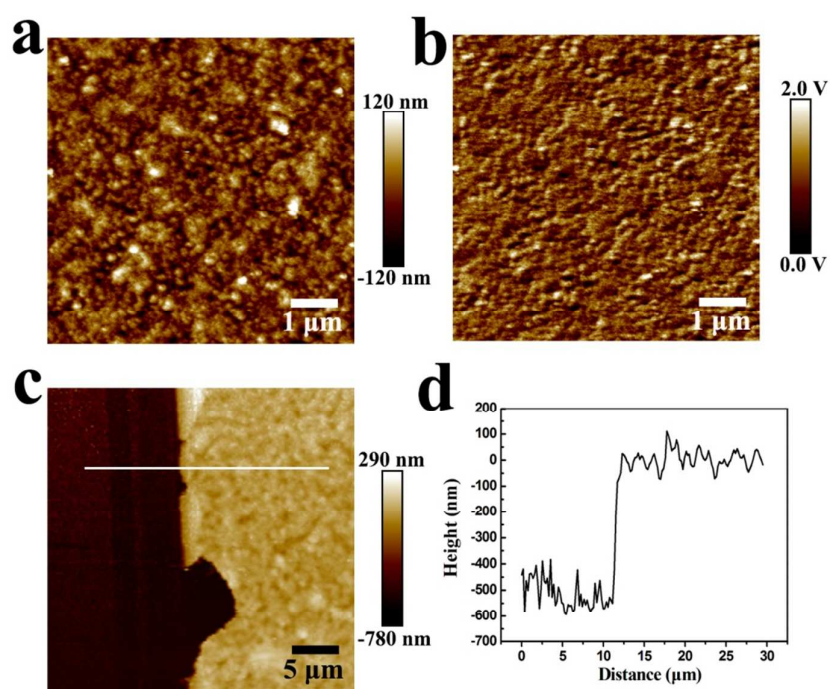


Figure S12. (a) AFM topographic image of perovskite film. (b) Surface potential image of the perovskite. (c) AFM topographic image of perovskite film, the darker region on the left is ITO substrate. (d) Height curve corresponding to the white line in panel c.

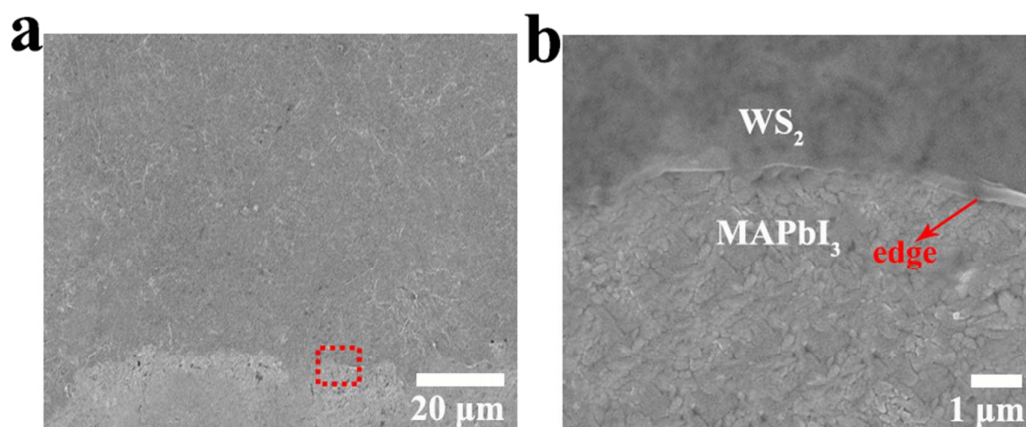


Figure S13. (a) SEM image of WS₂/MAPbI₃ junction. (b) The zoom-in topographic image of the red frame region in (a).

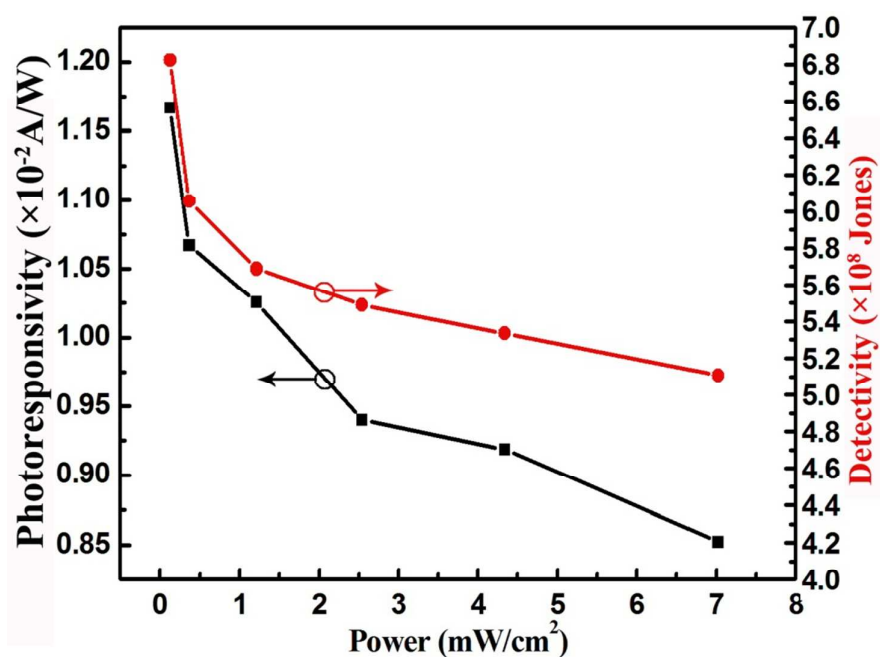


Figure S14. Photoresponsivity and detectivity of the MAPbI₃-only photodetector under -2.5 V.

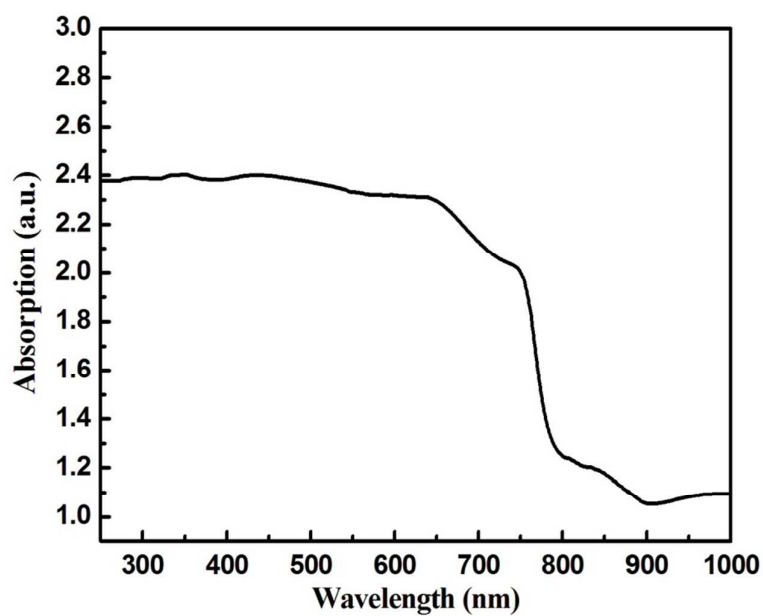


Figure S15. The absorption spectra of WS₂/MAPbI₃ junction.

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